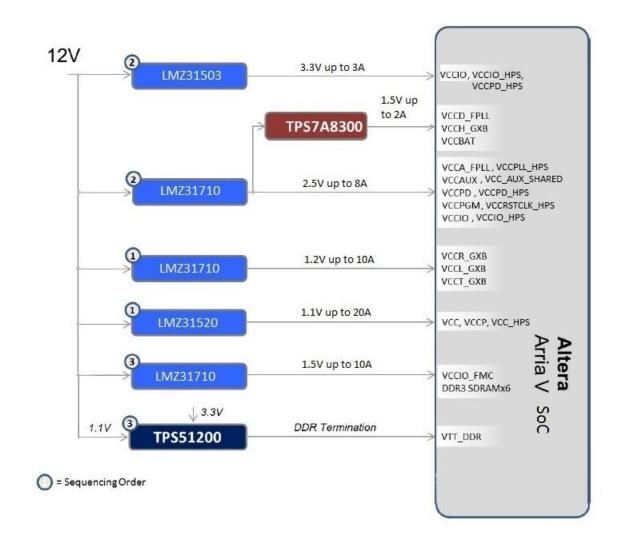
PMP9360 Test Results



1.	Block Diagram	2
	Startup/Sequencing	
	Synchronization	
	DDR Tracking	
	Efficiency	
	Load Step	
	Frequency Response	
/.	rrequency response	. 10



1. Block Diagram





2. Startup/Sequencing

The startup waveform is shown in Figure 1 and Figure 1.1. The input voltage is 12V, with no load at the output.

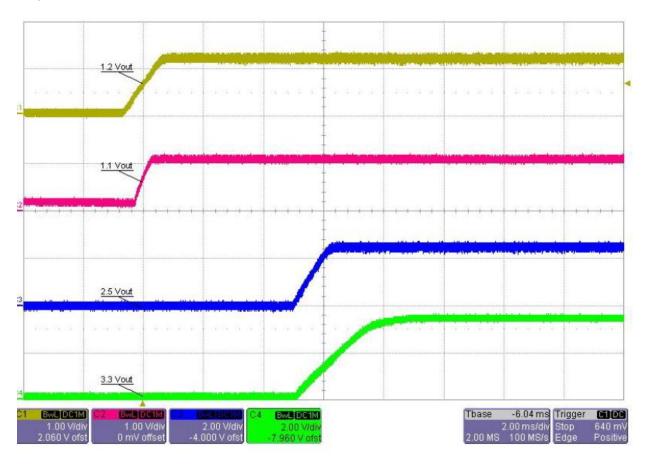


Figure 1

Ch1 => Output voltage 1.2V order #1
Ch2 => Output voltage 1.1V order #1
Ch3 => Output voltage 2.5V order #2
Ch4 => Output voltage 3.3V order #2
2ms/div
Full Bandwidth



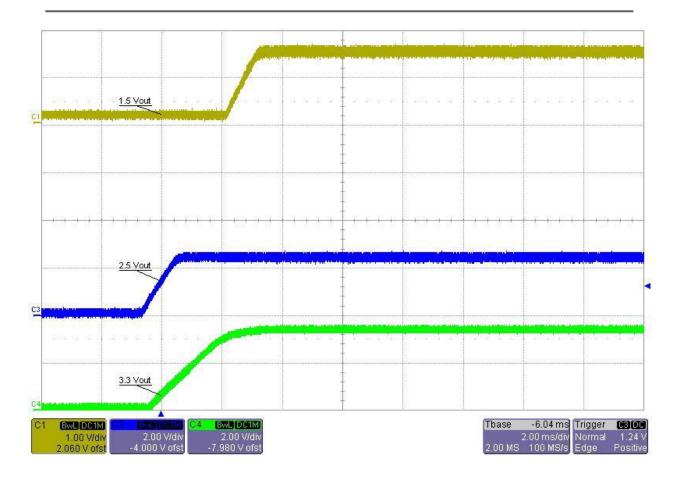


Figure 2.1
Ch1 => Output voltage 1.5V order #3
Ch3 => Output voltage 2.5V order #2
Ch4 => Output voltage 3.3V order #2
2ms/div
Full Bandwidth



A selection of startup waveforms is shown in Figure 1.2 to demonstrate LDO startup. The input voltage is 12V, with no load at the output.

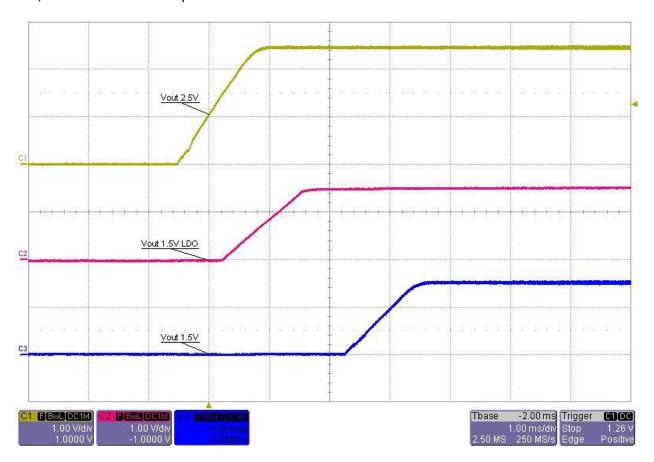


Figure 1.2

Ch1 => Output voltage 2.5V order #2

Ch2 => LDO Output voltage 1.5V order #2 + LDO delay

Ch2 => Output Voltage 1.5V order #3

2.5ms/div

Full Bandwidth



3. Synchronization

The switching nodes of the buck stages are shown in Figure 2 and Figure 2.1. The input voltage is 12V, with no load at the output.

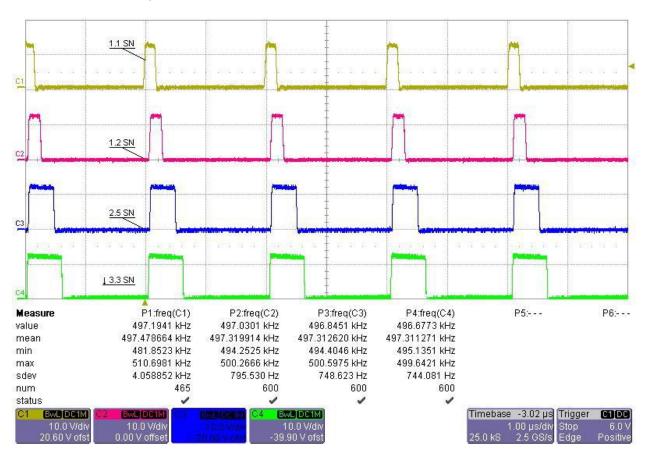


Figure 3

Ch1 => Switching node for 1.1 Vout Ch2 => Switching node for 1.2 Vout Ch3 => Switching node for 2.5 Vout Ch4 => Switching node for 3.3 Vout Common frequency: 500 kHz 1µs/div



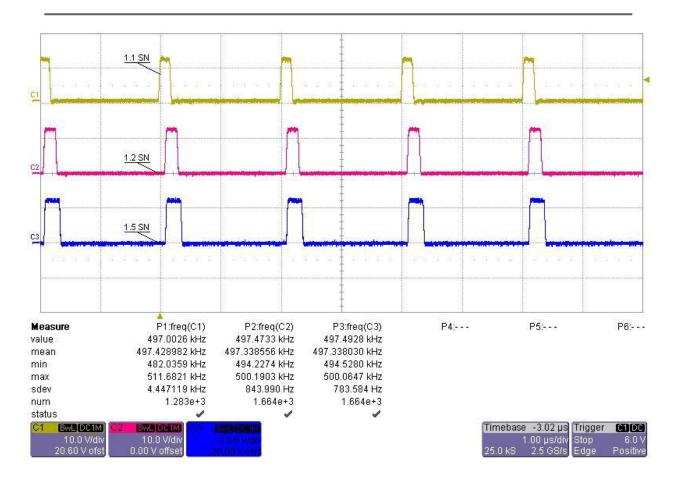


Figure 4.1

Ch1 => Switching node for 1.1 Vout Ch2 => Switching node for 1.2 Vout Ch3 => Switching node for 1.5 Vout Common frequency: 500 kHz

1μs/div

Full Bandwidth



4. DDR Tracking

DDR tracking is shown in the Figures 5 and 6.

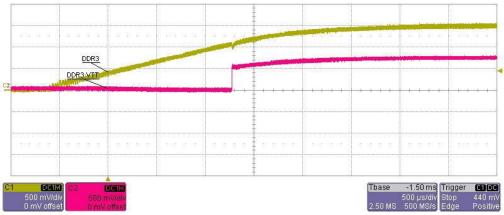


Figure 2

Ch1 => DDR3 1.5V output voltage from buck stage Ch2 => DDR3 0.75V termination voltage from TPS51200 500µs/div Full Bandwidth

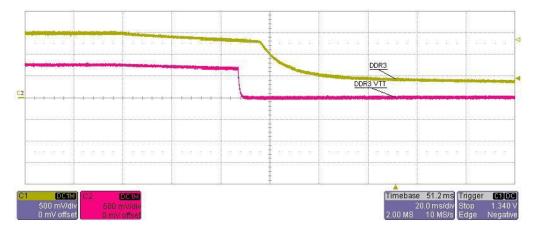


Figure 3

Ch1 => DDR3 1.5V output voltage from buck stage Ch2 => DDR3 0.75V termination voltage from TPS51200 20ms/div Full Bandwidth



5. Efficiency

The respective efficiencies of the buck stages providing 3.3V, 2.5V, 1.2V, 1.1V, and 1.5V are shown in Figures 7, 8, 9, 10, and 11 below. The input voltage is 12V.

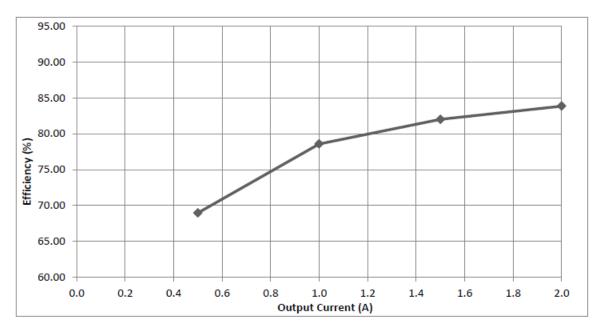


Figure 7: TPS84320 3.3V Output

VIN (V)	lin (A)	Vout (V)	IOUT (A)	PIN (W)	Pout (W)	Eff (%)
12.00	0.20	3.31	0.5	2.400	1.655	68.96
12.00	0.35	3.3	1.0	4.200	3.300	78.57
12.00	0.50	3.28	1.5	6.000	4.920	82.00
12.00	0.65	3.27	2.0	7.800	6.540	83.85

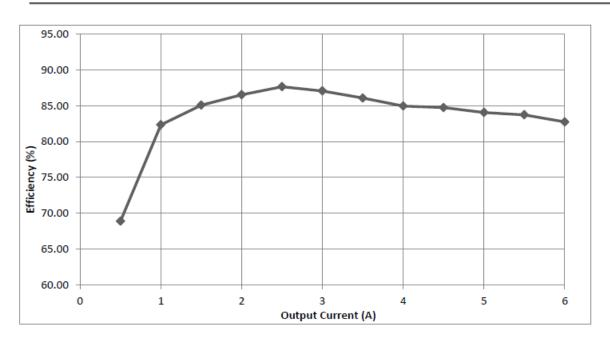


Figure 8: TPS84A20 2.5V Output

VIN (V)	lin (A)	V оит (V)	IOUT (A)	PIN (W)	Pout (W)	Eff (%)
12.00	0.15	2.48	0.5	1.800	1.240	68.89
12.00	0.25	2.47	1.0	3.000	2.470	82.33
12.00	0.36	2.45	1.5	4.320	3.675	85.07
12.00	0.47	2.44	2.0	5.640	4.880	86.52
12.00	0.58	2.44	2.5	6.960	6.100	87.64
12.00	0.70	2.42	3.0	8.340	7.260	87.05
12.00	0.81	2.39	3.5	9.720	8.365	86.06
12.00	0.93	2.37	4.0	11.160	9.480	84.95
12.00	1.04	2.35	4.5	12.480	10.575	84.74
12.00	1.16	2.34	5.0	13.920	11.700	84.05
12.00	1.27	2.32	5.5	15.240	12.760	83.73
12.00	1.39	2.30	6.0	16.680	13.800	82.73



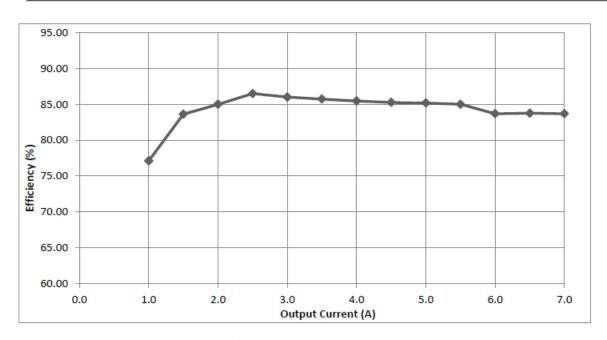


Figure 9: TPS84A20 1.2V Output

VIN (V)	lin (A)	V оит (V)	IOUT (A)	PIN (W)	Pout (W)	Eff (%)
11.99	0.13	1.20	1.0	1.559	1.202	77.12
11.98	0.18	1.20	1.5	2.156	1.803	83.61
11.98	0.24	1.20	2.0	2.875	2.404	84.99
11.98	0.29	1.20	2.5	3.474	3.005	86.49
11.98	0.35	1.20	3.0	4.193	3.606	86.00
11.97	0.41	1.20	3.5	4.908	4.207	85.72
11.97	0.47	1.20	4.0	5.626	4.808	85.46
11.97	0.53	1.20	4.5	6.344	5.409	85.26
11.96	0.59	1.20	5.0	7.056	6.010	85.17
11.96	0.65	1.20	5.5	7.774	6.608	85.00
11.96	0.72	1.20	6.0	8.611	7.206	83.68
11.95	0.78	1.20	6.5	9.321	7.807	83.75
11.96	0.84	1.20	7.0	10.046	8.407	83.68



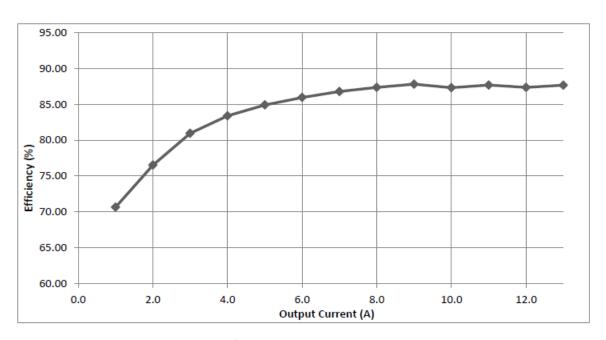


Figure 10: TPS84B20 1.1V Output

Vin (V)	lin (A)	V оит (V)	IOUT (A)	Pin (W)	Pout (W)	Eff (%)
12.01	0.13	1.10	1.0	1.561	1.103	70.65
12.00	0.24	1.10	2.0	2.880	2.204	76.51
12.00	0.34	1.10	3.0	4.080	3.303	80.96
12.00	0.44	1.10	4.0	5.280	4.403	83.39
12.00	0.54	1.10	5.0	6.480	5.502	84.91
12.00	0.64	1.10	6.0	7.680	6.601	85.95
11.99	0.74	1.10	7.0	8.873	7.700	86.78
11.99	0.84	1.10	8.0	10.072	8.798	87.35
11.99	0.94	1.10	9.0	11.271	9.896	87.80
11.99	1.05	1.10	10.0	12.590	10.992	87.31
11.99	1.15	1.10	11.0	13.789	12.089	87.67
11.98	1.26	1.10	12.0	15.095	13.186	87.35
11.98	1.36	1.10	13.0	16.293	14.282	87.66

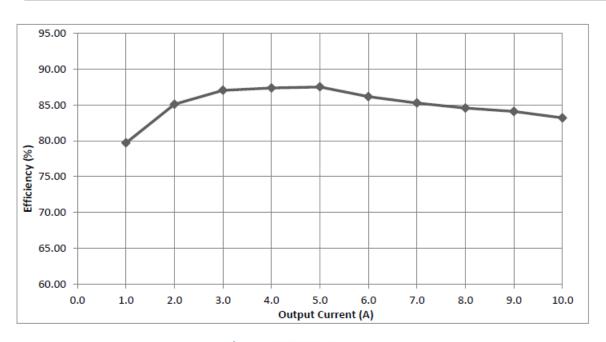


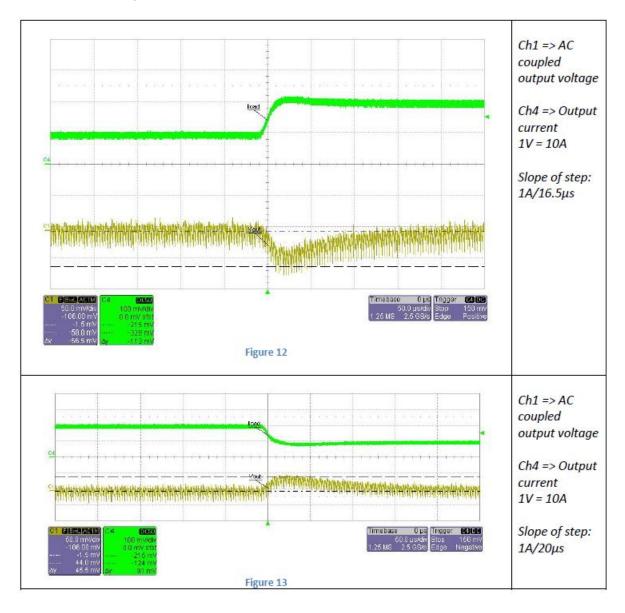
Figure 11: TPS84A20 1.5V Output

VIN (V)	lin (A)	V оит (V)	IOUT (A)	PIN (W)	Pout (W)	Eff (%)
11.99	0.16	1.53	1.0	1.918	1.529	79.70
11.98	0.30	1.53	2.0	3.594	3.058	85.09
11.97	0.44	1.53	3.0	5.267	4.584	87.04
11.96	0.59	1.53	4.0	6.997	6.112	87.36
11.96	0.73	1.53	5.0	8.731	7.640	87.51
11.95	0.89	1.53	6.0	10.636	9.162	86.15
11.94	1.05	1.53	7.0	12.537	10.689	85.26
11.94	1.21	1.53	8.0	14.447	12.216	84.56
11.93	1.37	1.53	9.0	16.344	13.743	84.09
11.92	1.54	1.53	10.0	18.357	15.270	83.18



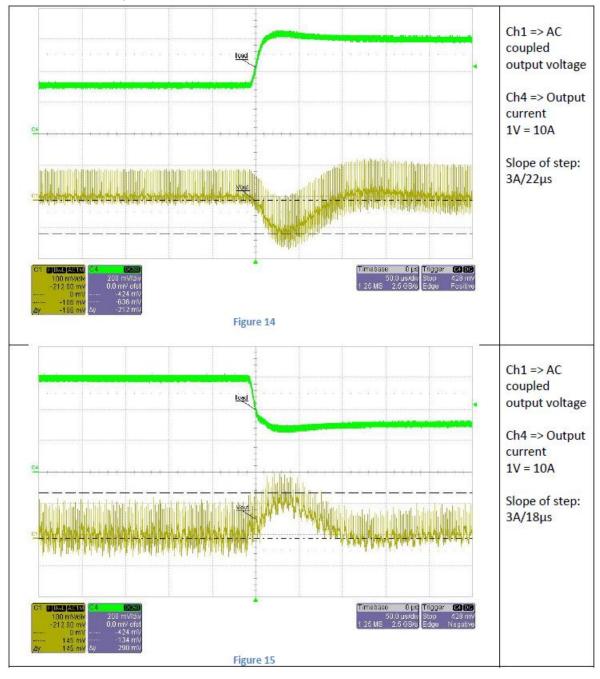
6. Load Step

The load regulation of the TPS84320 3.3V output is shown in Figures 12 and 13 below. The input voltage is 12V. The load step increases from 1A to 2A.



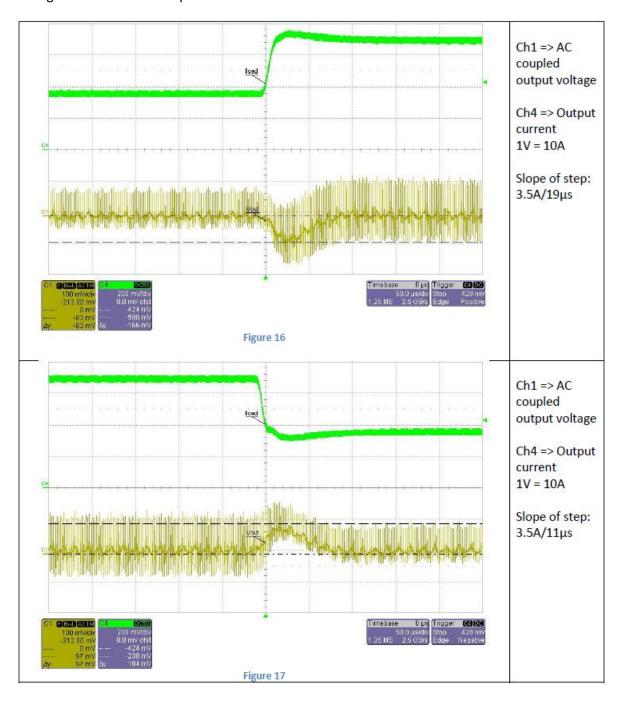


The load regulation of the TPS84A20 2.5V output is shown in Figures 14 and 15 below. The input voltage is 12V. The load step increases from 3A to 6A.



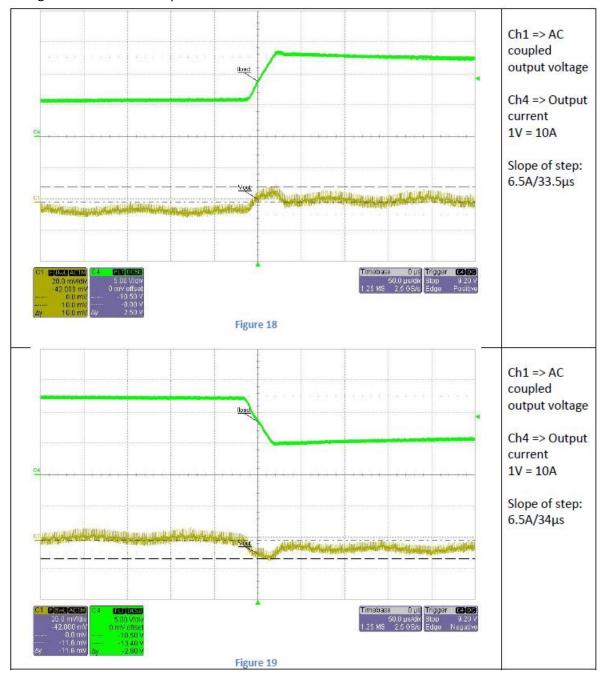


The load regulation of the TPS84A20 1.2V output is shown in the Figures 16 and 17 below. The input voltage is 12V. The load step increases from 3.5A to 7A.



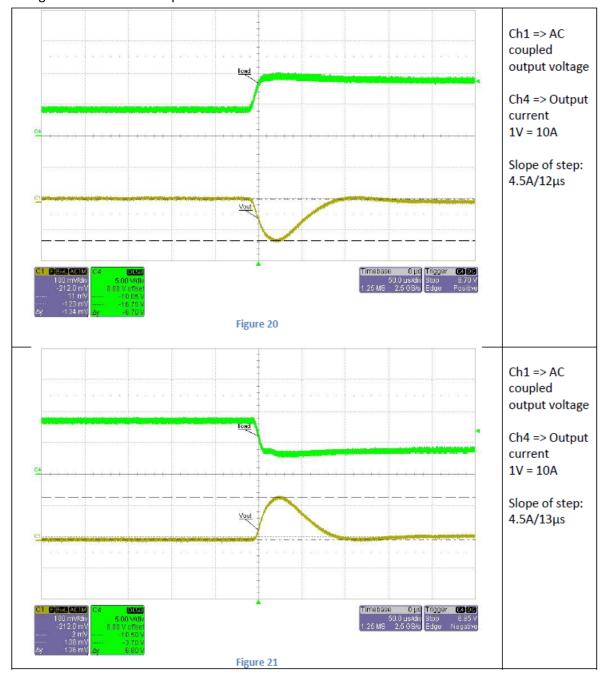


The load regulation of the TPS84B20 1.1V output is shown in the Figures 18 and 19 below. The input voltage is 12V. The load step increases from 6.5A to 13A.



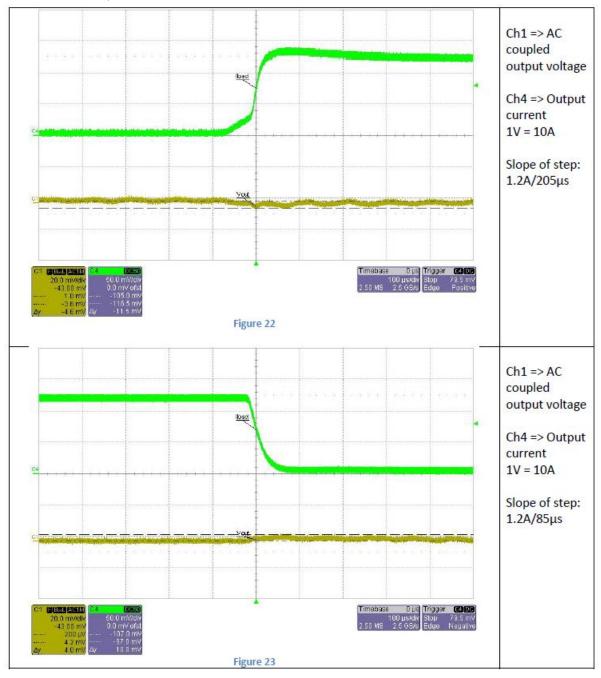


The load regulation of the TPS84A20 1.5V output is shown in the Figures 20 and 21 below. The input voltage is 12V. The load step increases from 4.5A to 9A.





The load regulation of the 1.5V LDO output is shown in the Figures 22 and 23 below. The input voltage is 12V. The load step increases from 0A to 1.2A.





7. Frequency Response

Figure 24 shows the loop response of the TPS84320 3.3V output with 1A load and 12V input.

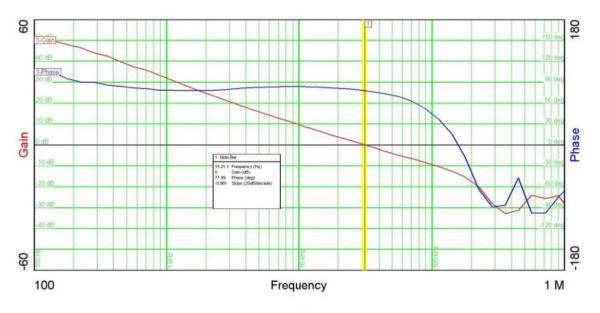


Figure 24

Table 1 summarizes the results from Figure 24.

Bandwidth (kHz)	31.21
Phase Margin	77.99°
Slope (20dB/Decade)	-0.981

Table 1



Figure 25 shows the loop response of the TPS84A20 2.5V output with 3A load and 12V input.

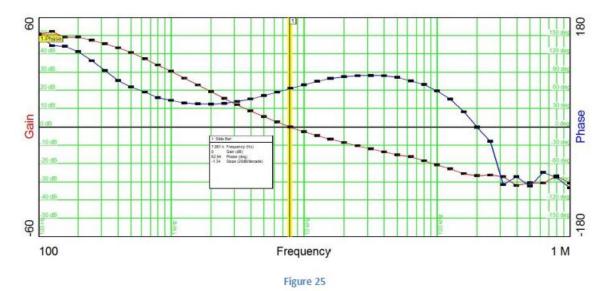


Table 2 summarizes the results from Figure 25.

Bandwidth (kHz)	7.861
Phase Margin	62.94°
Slope (20dB/Decade)	-1.34

Table 2



Figure 26 shows the loop response of the TPS84A20 1.2V output with 3.5A load and 12V input.

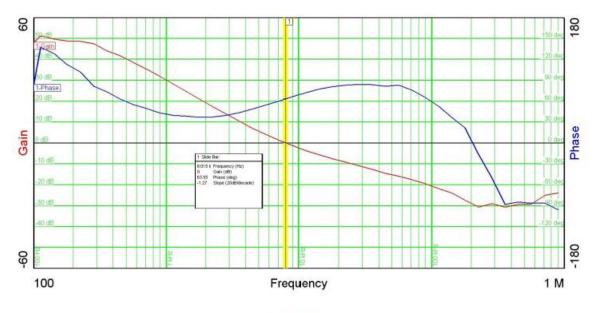


Figure 26

Table 3 summarizes the results from Figure 26.

Bandwidth (kHz)	8.015
Phase Margin	63.55°
Slope (20dB/Decade)	-1.27

Table 3



Figure 27 shows the loop response of the TPS84B20 1.1V output with 2A load and 12V input.

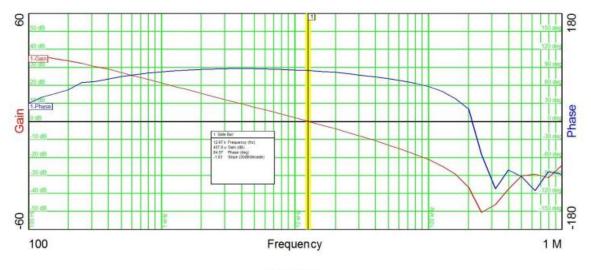


Figure 27

Table 4 summarizes the results from Figure 26.

Bandwidth (kHz)	12.67
Phase Margin	84.57°
Slope (20dB/Decade)	-1.03

Table 4



Figure 28 shows the loop response of the TPS84A20 1.5V output with 5A load and 12V input.

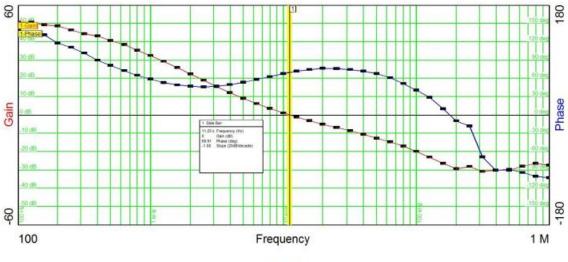


Figure 28

Table 5 summarizes the results from Figure 26.

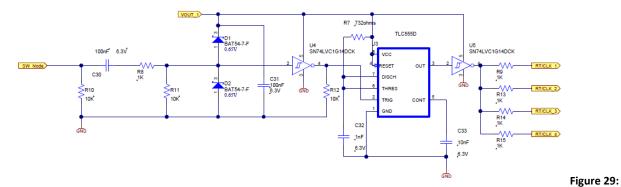
Bandwidth (kHz)	11.25
Phase Margin	69.9°
Slope (20dB/Decade)	-1.08

Table 5

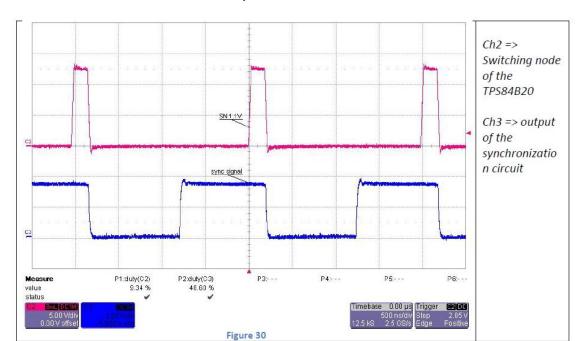


8. Miscellaneous

In order to synchronize the different buck stages, a square wave clock signal is required with a duty cycle between 20% and 80%. The TPS84B20 is used as the master clock but its duty cycle is only 9.2%. The following schematic and figure show the circuit used in order to provide a clock signal with 50% duty cycle.



Synchronization circuit



Ch2 => Measured duty cycle of the switching node: 9.3%

Ch3 => Measured duty cycle of the synchronization signal: 48.6%

PMP9360 Test Results



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PMP9360 Test Results



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